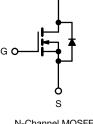




## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	250				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.28				
Q <sub>g</sub> max. (nC)	68				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	35				
Configuration	Single				





N-Channel MOSFET

### **FEATURES**

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF644PbF		
Lead (FD)-free	SiHF644-E3		
SnPb	IRF644		
	SiHF644		

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	250	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		14		
Continuous Drain Current	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	8.5	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	550	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	14	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	125	W	
Peak Diode Recovery dV/dt c			dV/dt	4.8	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering Recommendations (Peak temperature) <sup>d</sup>	lering Recommendations (Peak temperature) <sup>d</sup> for 10 s			300	°C	
Mounting Torque	6 20	0.00		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. V<sub>DD</sub> = 50 V, starting T<sub>J</sub> = 25 °C, L = 4.5 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 14 A (see fig. 12). c. I<sub>SD</sub>  $\leq$  14 A, dI/dt  $\leq$  150 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C. d. 1.6 mm from case.

S16-0754-Rev. D, 02-May-16

1 For technical questions, contact: hvm@vishay.com

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					ļ	ļ	ļ -
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		250	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.34	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>		V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	-	$V_{\rm GS} = \pm 20 \rm V$	-	-	± 100	nA
			250 V, V <sub>GS</sub> = 0 V	-	-	25	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8.4 A <sup>b</sup>	-	-	0.28	Ω
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =	50 V, I <sub>D</sub> = 8.4 A <sup>b</sup>	6.7	-	-	S
Dynamic				<u>.</u>	Į	Į	
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V,$	-	1300	-	
Output Capacitance	C <sub>oss</sub>		$V_{\rm DS} = 25 V,$	-	330	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0	0 MHz, see fig. 5	-	85	-	
Total Gate Charge	Qg				-	68	1
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 7.9 \text{ A}, V_{DS} = 200 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	11	nC
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 0 and 15	-	-	35	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 125 V, I <sub>D</sub> = 7.9 A, R <sub>g</sub> = 9.1 Ω, R <sub>D</sub> = 8.7 Ω, see fig. 10 <sup>b</sup>		-	11	-	
Rise Time	t <sub>r</sub>			-	24	-	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	53	-	
Fall Time	t <sub>f</sub>			-	49	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	package and o die contact	package and center of		7.5	-	nH
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.3	-	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	_
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	56	A
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25 \ ^{\circ}C, I_{S} = 14 \text{ A}, V_{GS} = 0 \text{ V}^{\text{b}}$		-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_{\rm J} = 25 ^{\circ}\text{C}$ , $I_{\rm F} = 7.9 \text{A}$ , dl/dt = 100 A/µs <sup>b</sup>		-	250	500	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.3	4.6	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )					

### Notes

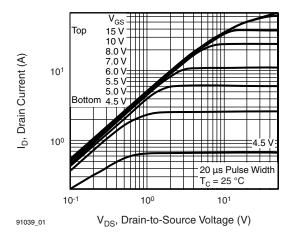
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





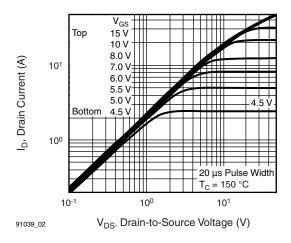


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \ ^\circ C$ 

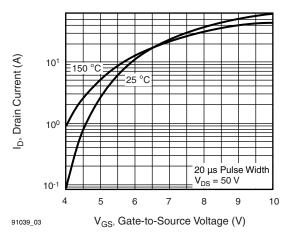


Fig. 3 - Typical Transfer Characteristics

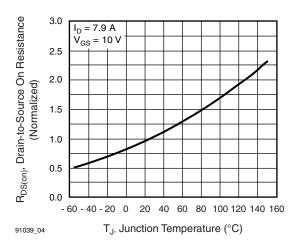


Fig. 4 - Normalized On-Resistance vs. Temperature

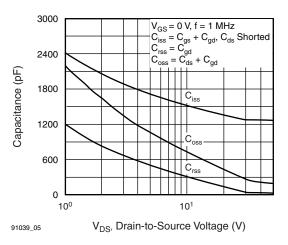


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

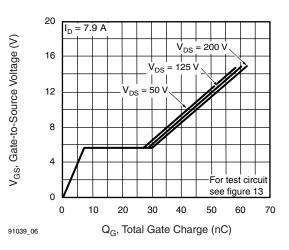


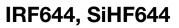
Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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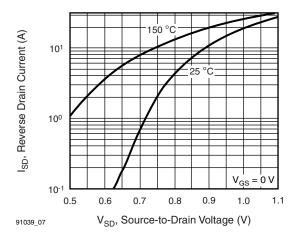


Fig. 7 - Typical Source-Drain Diode Forward Voltage

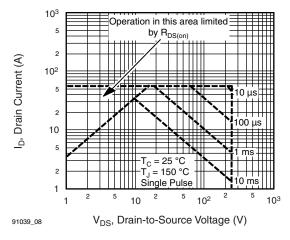


Fig. 8 - Maximum Safe Operating Area

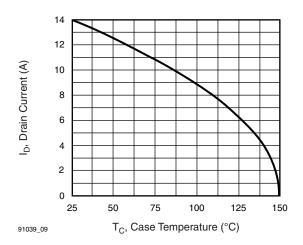


Fig. 9 - Maximum Drain Current vs. Case Temperature

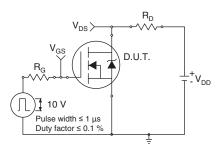


Fig. 10a - Switching Time Test Circuit

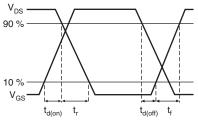


Fig. 10b - Switching Time Waveforms

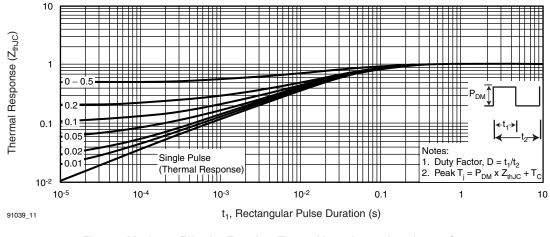


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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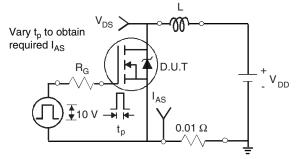
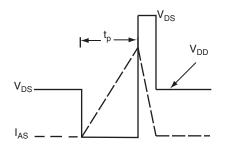


Fig. 12a - Unclamped Inductive Test Circuit



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Fig. 12b - Unclamped Inductive Waveforms

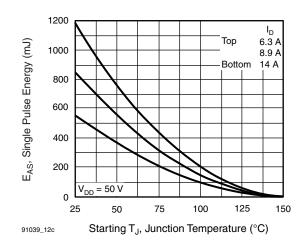


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

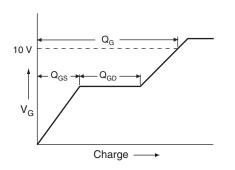


Fig. 13a - Basic Gate Charge Waveform

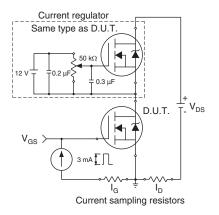


Fig. 13b - Gate Charge Test Circuit

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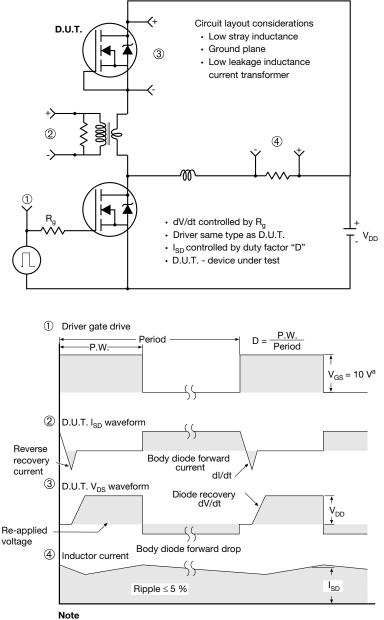
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

#### Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	MILLIMETERS		INCHES	
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
ASE		Xi	'an	
		IRF 9510 744K AB		

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